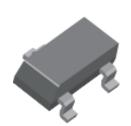
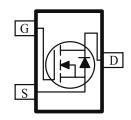
N-Channel 100V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

PRODUCT SUMMARY				
$V_{DS}(V)$	$r_{DS(on)}(\Omega)$	$I_{D}(A)$		
100	$0.280 @V_{CS} = 10 V$	1.8		
100	$0.355 @V_{CS} = 5.5V$	1.6		

- $\begin{array}{ll} \bullet & \quad \text{Low } r_{DS(on)} \text{ provides higher efficiency and} \\ \text{ extends battery life} \\ \end{array}$
- Low thermal impedance copper leadframe SOT-23 saves board space
- Fast switching speed
- High performance trench technology





ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C UNLESS OTHERWISE NOTED)					
Parameter Parameter			Maximum	Units	
Drain-Source Voltage			100	V	
Cate-Source Voltage			±20	V	
Continuous Drain Current ^a	T _A =25°C	I_D	1.8	Α	
Pulsed Drain Current ^b			±10	A	
Continuous Source Current (Diode Conduction) ^a			1.1	A	
Power Dissipation ^a	$T_A=25^{\circ}C$	P_{D}	1.30	W	
Operating Junction and Storage Temperature Range			-55 to 150	$^{\circ}\!\mathrm{C}$	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Тур	Max			
Maning Tangking 4 - Amiliant ^a	t <= 10 sec	R_{thJA}	93	110	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		130	150		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

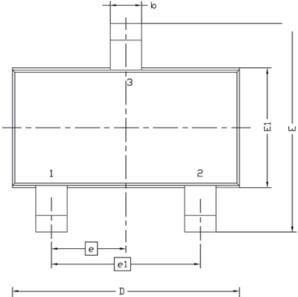
D	6 .1.1	T . C . T.	Limits			TT	
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Gate-Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$	1.0			V	
Gate-Body Leakage	Igss	$V_{DS} = 0 V, V_{CS} = \pm 8 V$			±100	nA	
Zana Cata Valta and Davis Garant	T	$V_{DS}=80 \text{ V}, V_{GS}=0 \text{ V}$	1				
Zero Gate Voltage Drain Gurrent	Ides	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			10	uA	
On-State Drain Current ^A	ID(on)	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	10			Α	
A	IDS(on)	$V_{GS} = 10 \text{ V}, I_{D} = 1.8 \text{ A}$			280		
Drain-Source On-Resistance ^A		$V_{GS} = 5.5 \text{ V}, I_D = 1.6 \text{ A}$			355	mΩ	
Forward Tranconductance ^A	gs	$V_{DS} = 10 \text{ V}, I_D = 1.8 \text{ A}$		11.3		S	
Diode Forward Voltage	Vsd	$I_S = 1.6 A, V_{GS} = 0 V$		0.75		V	
Dynamic ^b							
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{OS} = 5.5 \text{ V}, I_D = 1.8 \text{ A}$		7.0		nC	
Gate-Source Charge	Qgs			1.1			
Gate-Drain Charge	$Q_{\rm gd}$			2.0			
Tum-On Delay Time	td(on)			8			
Rise Time	$t_{\rm r}$	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 15 \Omega, \text{ I}_{D} = 1 \text{ A},$ $V_{GEN} = 4.5 \text{ V}$		24		ns	
Tum-Off Delay Time	td(off)			35			
Fall-Time	tr			10			

Notes

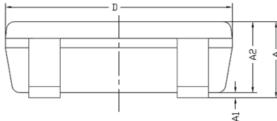
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

Analog Power SOT-23

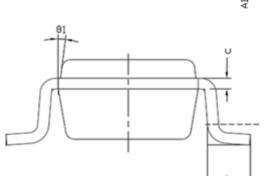
Package Information

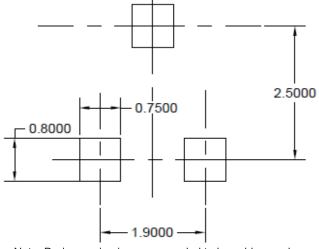


Symbol	MILLIMETERS		
Syllibol	MIN	MAX	
Α	0.8	1.2	
A1	0	0.1	
A2	0.7	1.1	
b	0.3	0.5	
С	0.1	0.2	
D	2.7	3.1	
Е	2.6	3	
E1	1.4	1.8	
е	0.95 BSC		
e1	1.9 BSC		
L	0.3	0.6	
θ1	7° NOM		



Recommended Pad Layout





Note: Drain opening is recommended to be solder mask defined in a copper fill for improved thermal performance

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